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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/436,598	11/09/1999	ANDREAS LENNIGER	GR-97-P-1593	6870
7	590 02/04/2003			
LERNER AND GREENBERG P A POST OFFICE BOX 2480 HOLLYWOOD, FL 330222480			EXAMINER	
			GRAYBILL, DAVID E	
			ART UNIT	PAPER NUMBER
			2827	

DATE MAILED: 02/04/2003

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)
_	09/436,598	LENNIGER ET AL.
Office Action Summary	Examiner	Art Unit
	David E Graybill	2827
The MAILING DATE of this communication appeared for Reply	ppears on the cover sheet	vith the correspondence address
A SHORTENED STATUTORY PERIOD FOR REP THE MAILING DATE OF THIS COMMUNICATION  - Extensions of time may be available under the provisions of 37 CFR 1 after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a re  - If NO period for reply is specified above, the maximum statutory perio  - Failure to reply within the set or extended period for reply will, by statu.  - Any reply received by the Office later than three months after the mail earned patent term adjustment. See 37 CFR 1.704(b)  Status	l.  1.136(a). In no event, however, may  sply within the statutory minimum of the d will apply and will expire SIX (6) Moute, cause the application to become	a reply be timely filed  irty (30) days will be considered timely  DNTHS from the mailing date of this communication.  ABANDONED (35 U.S.C. § 133).
1) Responsive to communication(s) filed on <u>09</u>	December 2002	
	This action is non-final.	
Since this application is in condition for allow closed in accordance with the practice under the condition of the condi	wance except for formal m	
Disposition of Claims		
4)⊠ Claim(s) <u>1 and 3-7</u> is/are pending in the app		
4a) Of the above claim(s) is/are withdr	awn from consideration.	
5) Claim(s) is/are allowed.		
6)⊠ Claim(s) <u>1 and 3-7</u> is/are rejected.		
7) Claim(s) is/are objected to.		
8) Claim(s) are subject to restriction and Application Papers	or election requirement.	
9) The specification is objected to by the Examir	ner	
10) ☐ The drawing(s) filed on is/are: a) ☐ acc		the Evaminer
Applicant may not request that any objection to	•	
11) The proposed drawing correction filed on		
If approved, corrected drawings are required in r		
12) The oath or declaration is objected to by the E	Examiner.	
Priority under 35 U.S.C. §§ 119 and 120		
13) Acknowledgment is made of a claim for foreign	gn priority under 35 U.S.C	. § 119(a)-(d) or (f).
a) ☐ All b) ☐ Some * c) ☐ None of:		
1. Certified copies of the priority docume	nts have been received.	
2. Certified copies of the priority docume	nts have been received in	Application No
<ul> <li>3. Copies of the certified copies of the pri application from the International E</li> <li>* See the attached detailed Office action for a list</li> </ul>	Bureau (PCT Rule 17.2(a))	
14) ☐ Acknowledgment is made of a claim for domes	•	
a) The translation of the foreign language p	provisional application has	been received.
Attachment(s)	,,	00
<ol> <li>Notice of References Cited (PTO-892)</li> <li>Notice of Draftsperson's Patent Drawing Review (PTO-948)</li> <li>Information Disclosure Statement(s) (PTO-1449) Paper No(s)</li> </ol>	5) Notice of	v Summary (PTO-413) Paper No(s)  f Informal Patent Application (PTO-152)

Application/Control Number: 09/436,598

Art Unit: 2827

A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on 11-4-2 has been entered.

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in

Application/Control Number: 09/436,598

Art Unit: 2827

order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(f) or (g) prior art under 35 U.S.C. 103(a).

Claims 1 and 3-6 are rejected under 35 U.S.C. 103(a) as being unpatentable over Nakamura (7153906).

At page 1, line 10 to page 2, line 13; and page 6, line 11 to page 7, line 14, applicant admits as conventional the following:

1. A power semiconductor module, comprising: semiconductor components 10 and connecting elements 8; a plastic housing 2 having an interior, an inside, and openings formed therein, said openings having an inner side adjacent said interior; a substrate 4 disposed in said plastic housing defining a housing base of said plastic housing, said substrate containing a ceramic plate 5 having a top side and a bottom side with a top metallization layer 6 disposed on said top side and a bottom metallization layer 7 disposed on said bottom side, said top metallization layer facing said interior of said plastic housing being patterned in order to form conductive interconnects and equipped for and receiving said semiconductor components and said connecting elements; terminal elements 11 in said plastic housing for providing external terminals, said terminal elements being press-fitted into said openings in said plastic housing;

Application/Control Number: 09/436,598

Art Unit: 2827

and wires 8 bonded to said terminal elements and to said semiconductor components.

- 3. The power semiconductor module according to 1, wherein said terminal elements run approximately parallel to said housing base in said interior of said plastic housing.
- 4. The power semiconductor module according to 1, wherein said plastic housing includes a frame 9 and a cover.
- 5. The power semiconductor module according to 4, wherein said terminal elements are disposed in said frame.
- 6. The power semiconductor module according to 1, wherein said substrate is covered with a potting compound [illustrated in FIG 1].

Although applicant's admitted prior art does not appear to explicitly teach the terminal elements press-fitted into the openings, the product of applicants admitted prior art inherently possesses the structure imparted by this process limitation.

However, applicant does not appear to explicitly admit as conventional a flat inside, the terminal elements having lugs, the terminal elements in the region of the lugs being pressfitted into the openings in the plastic housing, the terminal elements bearing on the flat inside of the plastic housing, and

Application/Control Number: 09/436,598 Page 5

Art Unit: 2827

the lugs pressing against the inner side of the openings for fixing the terminal elements in position.

Nonetheless, in the English abstract and figures, Nakamura teaches a plastic housing ["resin case"] having a flat inside ["side wall"], terminal elements 10 having lugs [10b and the two lugs formed in the side of 10 and extending upward from 10a], the terminal elements in the region of the lugs being pressfitted into openings [4d and "slots" or "grooves"] in the plastic housing, the terminal elements bearing on the flat inside of the plastic housing, and the lugs pressing against the inner side of the openings for fixing the terminal elements in position. In addition, it would have been obvious to combine the product of Nakamura with the product of applicant's admitted prior art because it would enable easy manufacture of the module.

Claim 7 is rejected under 35 U.S.C. 103(a) as being unpatentable over the combination of applicants admitted prior art and Nakamura as applied to claim 6, and further in combination with Leukel (FR2535898).

The combination of applicant's admitted prior art and Nakamura does not appear to explicitly teach the following:

Art Unit: 2827

7. The power semiconductor module according to 6, wherein said potting compound is formed of a soft potting compound layer and a hard potting compound disposed on said soft potting compound.

Page 6

Nonetheless, at page 6, lines 11-21, Leukel teaches a product wherein said potting compound is formed of a soft potting compound layer 15 and a hard potting compound 16 disposed on said soft potting compound. Moreover, it would have been obvious to combine the invention of Leukel with the invention of applicants admitted prior art because it would increase package reliability.

Claim 7 is rejected under 35 U.S.C. 103(a) as being unpatentable over the combination of applicant's admitted prior art and Nakamura as applied to claims 1 and 3-6, and further in combination with Leukel (FR2535898).

The combination of applicant's admitted prior art and Nakamura does not appear to explicitly teach that the compound is formed of a soft potting layer and a hard potting layer disposed on the soft layer.

Nonetheless, at page 6, lines 11-21, Leukel teaches a compound formed of a soft potting layer 15 and a hard potting layer 16 disposed on the soft layer. Moreover, it would have been obvious to combine the invention of Leukel with the

Application/Control Number: 09/436,598 Page 7

Art Unit: 2827

invention of the applied prior art because it would increase package reliability.

Applicant's remarks filed 12-9-2 have been fully considered and are addressed supra and infra.

In response to applicant's argument that applicant has a different reason for, or advantage resulting from, doing what the applied prior art has suggested, it is noted that this is not demonstrative of nonobviousness. In re Kronig 190 USPQ 425, 428 (CCPA 1976); In re Lintner 173 USPQ 560 (CCPA 1972); indeed, the prior art motivation or advantage may be different than that of applicant while still supporting a conclusion of obviousness. In re Wiseman 201 USPQ 658 (CCPA 1979); Ex Parte Obiaya 227 USPQ 58 (Bd. of App. 1985). In any case, the applied prior art teaches the product of the instant invention; therefore, it possesses the same advantages.

Any telephone inquiry of a general nature or relating to the status (MPEP 203.08) of this application or proceeding should be directed to Group 2800 Customer Service whose telephone number is 703-306-3329.

Any telephone inquiry concerning this communication or earlier communications from the examiner should be directed to David E. Graybill at (703) 308-2947. Regular office hours: Monday through Friday, 8:30 a.m. to 6:00 p.m.

The fax phone number for group 2800 is 703/308-7722.

Art Unit: 2827

David E. Graybill Primary Examiner Art Unit 2827

D.G. 30-Jan-03